

Cyclo Olefin Polymer (COP)

ZEONEX®



ZEON CORPORATION



New high-performance thermoplastics for next-generation

For optics, electronics, and medical applications Another industry-leading development from ZEON CORPORATION

ZEONEX®— Cyclo Olefin Polymer(COP) offers excellent optical properties for creating optical parts for cameras and laser beam printers.

ZEONEX's high purity is suitable for a wide range of medical packaging products, while its low dielectric constant and loss tangents are appropriate for electrical insulation applications.



ZEONEX® Applications

Digital camera lenses, prisms and Mobile phone camera lenses

 $\sf ZEONEX^{\it B}$ has earned high marks for low moisture absorption, good transparency, and high precision molding ability.









Mirrors

ZEONEX's low moisture absorption, good dimensional stability, and high-precision molding are perfectly fit for mirrors.





Pickup lenses, LBP F θ lenses.

For pickup lenses and LBP F θ lenses, ZEONEX's low birefringence, low moisture absorption, and high-precision molding ability will bring high values.

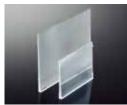


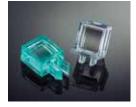


Other applications

ZEONEX® is also favored in electronics, medical packaging and optronics fields, with its outstanding heat resistance, low impurity, chemical resistance and electric properties.









ZEONEX® representative properties

Properties	Measurement methods	Unit	Requirements	ZEONEX®K22R	
Specific gravity	ASTM D792	-	-	1.01	
Water absorption	ASTM D570	%	-	0.014	
Heat distortion temperature	ASTM D648	${\mathbb C}$	1.82PaNo annealing	132	
Linear expansion coefficient	ASTM E831	cm/cm℃	-50~100°C	5.8×10^-5	
Izod impact srength	ASTM D256	J/m	3.2mm Notched	23	
Pencil hardness	JISK5401	-	-	F	
Volume resistivity	IEC93	Ωcm	-	1.3×10^17	
Dielectric breakdown strength	ASTM D149	kV/mm	short-time method,1mm	110	
Dielectric constant	IEC250	-	1MHz	2.5	
Dielectric loss tangent	IEC250	-	1MHz	0.003	

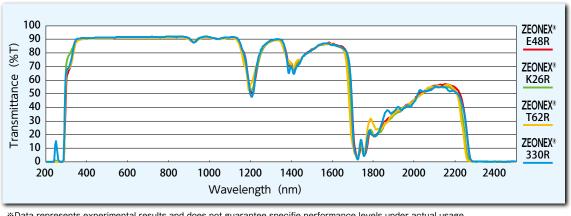
^{*}Data represents experimental results and does not guarantee specifie performance levels under actual usage.

ZEONEX® properties comparative

Properties	Measurement methods	Unit	Requirements		ZEONEX® K22R					
Refactive index	ASTM D542	-	-	1.535	1.535	1.531	1.535	1.536	1.509	1.525
Glass transition temperature	JIS K7121	$^{\circ}$	-	143	143	139	156	154	123	138
AAED	ISO 1133	g/	260℃ 21.18N						11	
MFR		10min	280℃ 21.18N	52	32	25	22	16		21
Flexual modulus	ISO 178	MPa	-	2360	2410	2240	2480	2540	2780	1930
Flexual strength	ISO 178	MPa	-	80	115	115	99	98	90	97
Tensile modulus	ISO 527	MPa	-	2530	2570	2450	2740	2650	3010	2100
Tensile strength	ISO 527	MPa	-	54	72	73	60	67	37	60
Tensile elogation	ISO 527	%	Surrender	-	5.2	5.5	-	-	-	5.5
Tensile elogation		%	Destruction	2.8	24	62	3.1	3.9	1.5	43
Flammability	IEC250	-	the UL standard	94HB	94HB	94HB	94HB	94HB	94HB	94HB

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Transmittance data 3mmplate 200-2500nm



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ZEONEX® characteristic properties

ZEONEX® basic molding properties



Air(oxygen) dissolved in ZEONEX® pellets can cause discoloration, carbide and the occurrence of voids. ZEONEX® should be dried (heated) to remove air in the pellets for 4 to 10 hours at the temperaturesre commended for each product number indicated below before molding. Drying for too long a period may cause heat deterioration, and possibly discoloration in the molded articles.

Product name	ZEONEX® 480R	ZEONEX® E48R		ZEONEX® K26R•K22R		ZEONEX® T62R
Recommended temperature	100~110℃	100~110℃	100~110℃	100~110℃	90~100℃	100~110℃

Standard in jection molding conditions Since molding conditions will differ depending on molding machine, shape and size of molded item, runner & sprue & gate design, please refer to the glass transition temperature and the recommended conditions below to determine with reference.

Product name	ZEONEX® 480R	ZEONEX® E48R	ZEONEX® F52R	ZEONEX® K26R•K22R	ZEONEX® 330R	ZEONEX® T62R			
Cylinder temperature	260~290℃	260~290℃	270~300℃	270~300℃	240~260℃	270~300℃			
Mold temperature	90~135℃	90~135℃	105~150℃	95~140℃	90~120℃	120~150℃			
Injection pressure	50~180MPa								
Holding pressure	50∼180MPa								
Back pressure	5~10MPa								
Injection speed	30~80cm ³ /sec								
Screw speed	20~60rpm								

Nitrogen sealing

(1) Necessity of Nitrogen Sealing

ZEONEX® is stable even at 280°C for 30 hours when oxygen is not present, so defects such as carbonization, burning and discoloration do not occur in products. Since these problems will arise in the presence of oxygen, nitrogen sealing should be used to prevent oxygen from entering into the injection molding process. Nitrogen sealing is very effective

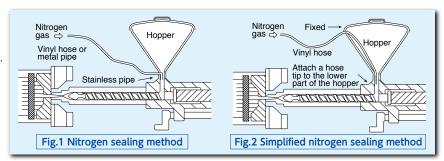
for molding optical parts, preventing discoloration and the entrance of contamination caused by resin decomposition.

(2) Nitrogen Sealing Method

Fig.1 Shows the method for nitrogen sealing, and Fig.2 shows a simplified nitrogen sealing method.

- (1) As shown below, feeding nitrogen to the lower part of the hopper prevents mixture with air. This is also effective when air is used for transport.
- (2) Before increasing the cylinder temperature, nitrogen is introduced in order to purge air from the inside of the cylinder. After this, the resin can be poured.
- (3) The flow rate of nitrogen depends on the capacity of the molding machine. For example, nitrogen

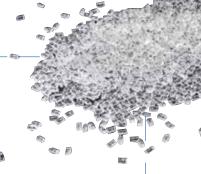
flow rate 15 liters/minute (cylinder diameter:15 to 30 mm;resin residence time:5to 30 minutes). Concentration of N2 should be 99% or higher, and a concentration of 99.9% or higher is recommended



*For more details, please ask ZEON

^{**}When a nitrogen sealing is applied, carefully monitor the increase in nitrogen density in the molding room and be sure to provide periodical ventilation.





PL(Product Liability) Notes

- 1. Please observe the following precautions for the storage and use of the product and items molded from the product.
 - (1) Keep away from fire, since ZEONEX® is combustible.
 - (2) Avoid exposure to direct sunlight and high-energy-light, which can make ZEONEX® discolorration.
 - (3) Do not use or expose to temperatures over heat distortion temperature, ZEONEX® may discolor, deform, or melt.
 - (4) Avoid exposure to high temperature for a long time, which can distort ZEONEX®
 - (5) Do not use under high heat temperature and near heat source; ZEONEX® may emit smoke or ignite.
 - (6) Do not use near high-energy-light source, ZEONEX® may emit smoke or ignite due to heat generation by light absorption.
 - (7) Improper molding conditions or use with a poorly designed mold may induce solvent cracking through residual stress.
 - (8) Do not use for parts that are subject to continuing load (snap fit insert molded products, screw stops, etc.); the material may crack.
 - (9) Do not expose to the following solvents and liquids which may cause ZEONEX® to liquefy or swell.
 - Aromatic solvents such as benzene, toluene, etc.
 - Chlorinated hydrocarbon solvents, including dichloromethane, carbon tetrachloride, etc.
 - Animai vegetable and mineral oils and greases
 - Hydrocarbon solvents such as n-Hexane, cyclohexane and ligroin, etc.
 - Ethers such as diethylether, etc.
 - Ketones such as cyclohexanone, etc.
 - Prior to use test other materials and liquids containing long-chain alkyl groups in their structure.
 - (10) Test ZEONEX® under the harsheet conditions to be encountered to determine the safety and suitability of the materials prior to use.
- 2. Contact ZEON CORPORATION before utilizing ZEONEX® in medical care products, foods or toys.
- 3. Please refer to the Safety Data Sheet for specific details.

Related laws and standards

TSCA : TSCA Inventory
 EINECS : EINECS Inventory

Other disclaimers and warnings

- (1) Specifications listed in the catalog are typical measurements using standard test methods, but are not intended to imply guaranteed values for all possible applications. Consequently, listed values may not be applicable to products used under differing conditions.
- (2) Catalog descriptions and specifications are subject to change without notice.
- (3) Applicable industrial patents and copyrights should be observed when adopting applications introduced in this catalog.
- (4) Physical properties cited for other resins are drawn from related catalogs and documents.
- (5) Contact ZEON CORPORATION for detailed technical information.
- 「ZEONEX®」 is the resistered trade mark of ZEON CORPORATION